PCN	Number:	201605	24001			PCN D	ate:	6/1/2016	
Title							5, 2, 2, 2, 2, 2, 2, 2, 2, 2, 2, 2, 2, 2,		
Customer Contact:					ept: Quality Services				
	inge Type:							-,	
	Assembly Site			Design		Wafe	r Bum	p Site	
	Assembly Process			Data Sheet		_	fer Bump Material		
	Assembly Materials			Part number change		Wafe	fer Bump Process		
	Mechanical Specification			Test Site		= -	r Fab Site		
	Packing/Shipping/Labeling			Test Process		= -	Wafer Fab Materials		
					Wafer Fab Process			Process	
Notification Details									
	cription of Chang			ouncing an informatio					
The product datasheet(s) is being updated as summarized below.  The following change history provides further details.									
	INSTRUMENTS  LP55231  SNOSCR5B – MARCH 2013 – REVISED MAY 2016								
Cha	Changes from Revision A (October 2014) to Revision B								
								<u>-</u> _	
	Added several new Applications								
	Added Community Resources section2  Changed Handling Ratings to ESD Ratings; moved storage temperature to Abs Max table4								
			_						
	<ul> <li>Changed R<sub>BJA</sub> value from 36.6C/W to 33.3C/W; add additional thermal information</li></ul>								
	,								
The	datasheet number	will be c	hanging						
Device Family			Change From:				ge To:		
LP!	LP55231			SNOSCR5A			SNOSCR5B		
These changes may be reviewed at the datasheet links provided. http://www.ti.com/product/LP55231									
Reason for Change:									
To more accurately reflect device characteristics.									
Ant	icipated impact o	on Fit, Fo	rm, Fu	nction, Quality or R	eliabil	ity (pos	itive	/ negative):	
No anticipated impact. This is a specification change announcement only. There are no changes to the actual device.									
Changes to product identification resulting from this PCN:									
Non	e.								
Pro	duct Affected:								
LP!	55231SQE/NOPB		LP5523	1SQX/NOPB	]				

For questions regarding this notice, e-mails can be sent to the regional contacts shown below or your local Field Sales Representative.

Location	E-Mail
USA	PCNAmericasContact@list.ti.com
Europe	PCNEuropeContact@list.ti.com
Asia Pacific	PCNAsiaContact@list.ti.com
Japan	PCNJapanContact@list.ti.com